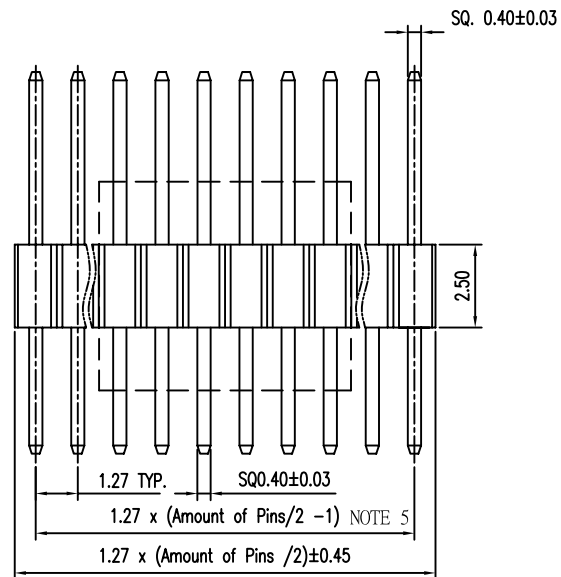




NOTE:

1. MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
2. FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u") MIN Ni OVER ALL
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260°C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION INFRA-RED
OR VAPOR PHASE REFLOW OVEN.
5. THE TOLERANCE OF THIS DIMENSION

2-50 PINS	± 0.20
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6. PRODUCT NUMBERING:

20021122 - 0 0 0 XX X X LF

LEAD FREE

PLATING:

1:GOLD FLASH ALL OVER

4:0.25um(10U")GOLD AT CONTACT

8:0.76um(30U")GOLD AT CONTACT

9:1u" GOLD OVER 30u" PdNi AT CONTACT

PACKING

T: TUBE

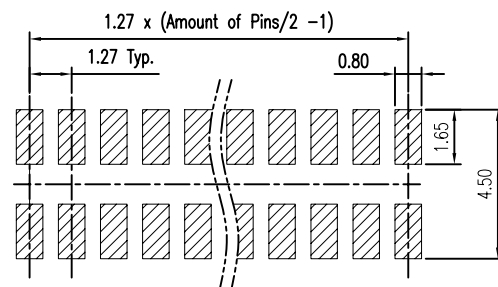
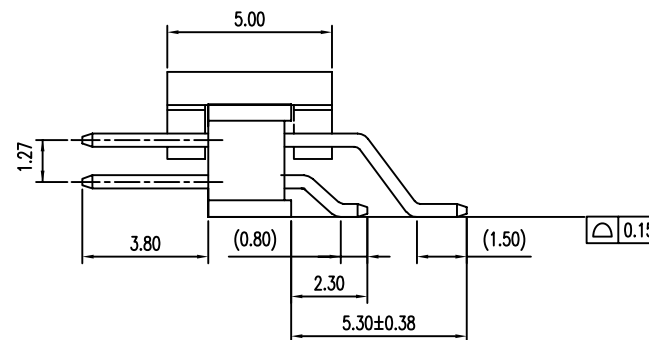
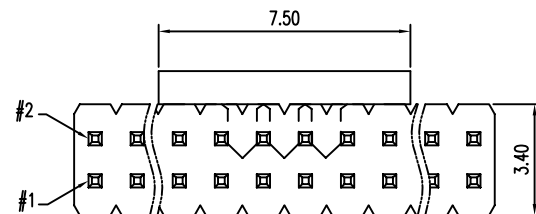
D: TUBE + CAP

C: REEL + CAP

PIN COUNT

08,10,..., 50

(8 -50 EVERY EVEN PIN)



Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

mat'l. code				surface	tolerance	projection	product family	
				ISO1302	ISO1101 ISO406		MINITEK	
ltr	ecn no	dr	date	tolerances	unless otherwise specified		title	
H	ELX-N-19179	TIM	10/24/14	angles	0.X±0.38	MM	1.27X1.27MM BTB HEADER	
B	T09-1155	S.LIN	12/03/09	0°±2°	0.XX±0.25	scale 5:1	UNSHROUDED SMT	
C	T10-0014	S.LIN	01/28/10	0°±2°	0.XXX±0.10		dwg no	
D	T11-0029	S.LIN	06/14/11	dr	STERLING LIN	09/15/09	sheet. 1 of 1	
E	ELX-N-010358	ZK	01/16/12	engr	STERLING LIN	09/15/09	size	
F	ELX-N-010619	ZK	03/12/12	chr	GRAY HSIEH	09/15/09	A4	
G	ELX-N-16465	TIM	12/06/13	appd	JOSEPH	09/15/09	type	
sheet				revision	H		Product Customer Drawing	
index				sheet	1			